

POWER MOSFET P CHANNEL

Devices

2N6898

**25 AMPERE
100 VOLTS
0.2 Ω**

- HIGH INPUT IMPEDANCE
- LOW $R_{DS(ON)}$
- MAJORITY CARRIER DEVICE
- LINEAR TRANSFER CHARACTERISTICS

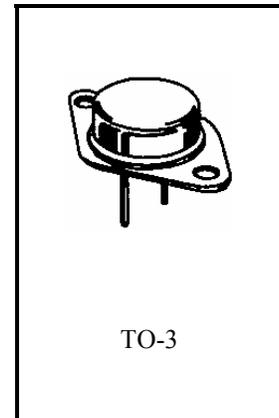
ABSOLUTE MAXIMUM RATINGS ($T_C = 25^{\circ}C$ unless otherwise noted)

Parameters/Test Conditions		Symbol	Value	Units
Drain-Source Voltage		V_{DS}	-100	V
Gate-Source Voltage		V_{GS}	+/-20	V
Continuous Drain Current	$T_C = 250C$	I_D	-25	A
Pulsed Drain Current(1)		I_{DM}	-60	A
Power Dissipation	$T_C = 250C$	P_D	150	W
Operating Junction & Storage Temperature Range		T_J, T_{stg}	-55 to +150	$^{\circ}C$
Lead Temperature (1/16" from case for 10 secs.)		T_L	260	$^{\circ}C$

THERMAL RESISTANCE RATINGS

Thermal Resistance	Symbol	Max.	Unit
Junction-to-Case	R_{thJC}	0.83	$^{\circ}C/W$

(1) Pulse width limited by maximum junction temperature



ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Parameters/Test Conditions	Symbol	Min.	Max.	Unit
Drain-Source Breakdown Voltage $V_{GS} = 0 V, I_D = 1000 \mu A$	$V_{(BR)DSS}$	-100		V
Gate Threshold Voltage $I_D = 250 \mu A$	$V_{GS(th)}$	-2	-4	V
Gate-Body Leakage $V_{GS} = \text{At Rated } V_{GS}$	I_{GSS}		100	nA
Zero Gate Voltage Drain Current $V_{DS} = -80 V$	I_{DSS}		1	μA
Zero Gate Voltage Drain Current $V_{DS} = -80V, T_J = 125^{\circ}C$	I_{DSS}		50	μA
Drain-Source On-State Resistance (2) $V_{GS} = -10V, I_D = 15.8 A$	$r_{DS(on)}$		0.2	Ω
Forward Transconductance (2) $V_{DS} = -10 V, I_D = 15.8 A$	g_{fs}	4	15	mho

ELECTRICAL CHARACTERISTICS (con't)

Parameters/Test Conditions		Symbol	Min.	Max.	Unit
Input Capacitance	$V_{GS} = 0$	C_{iss}		3000	
Output Capacitance	$V_{DS} = -25$ V	C_{oss}		1500	pF
Reverse Transfer Capacitance	$f = 0.1$ MHz	C_{rss}		500	
Turn-On Delay Time	$V_{ds} = -50$ V	$t_{d(on)}$		50	
Rise Time	$I_D = 12.5$ A	t_r		250	
Turn-Off Delay Time	$R_G = 50$ Ω	$t_{d(off)}$		400	ns
Fall Time	(Switching time is essentially independent of operating temperature.)	t_f		250	

SOURCE-DRAIN DIODE RATINGS & CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Continuous Current	I_D		25	A
Pulsed Current(1)	I_{DM}		60	A
Forward Voltage (2) $I_{SD} = 25$ A	V_{SD}	0.8	1.6	V
Reverse Recovery Time $I_F = 4$ A, $dI/dt = 100$ A/ μ S	t_{rr}		750	ns

- (1) Pulse width limited by maximum junction temperature
(2) Pulse Test: Pulse width < 300 μ sec. Duty Cycle \leq 2%

